

TPS60150EVM-359, TPS60151EVM-359

This user's guide describes the characteristics, operation, and use of the TPS60150EVM-359 and TPS60151EVM-359 evaluation modules (EVM). These EVMs have either the TPS60150 or TPS60151 ICs and supporting components configured as a charge pump that provides a 5-V output. This document includes EVM specifications, recommended test setup, test results, bill of materials (BOM), and a schematic diagram.

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1 Introduction

The Texas Instruments TPS6015XEVM-359 evaluation module uses either the TPS60150 or TPS60151 IC and supporting components configured as a charge pump that provides a 5-V output. The goal of the EVM is to facilitate evaluation of the TPS60150 or TPS60151 IC.

1.1 Performance Specification Summary

Table 1 provides a summary of the TPS6015XEVM-359 performance specifications. All specifications are given for an ambient temperature of 25°C.

Table 1. Typical Performance Specification Summary

| | Condition | | Voltage Range (V) | | | Current Range (mA) | | |
|------------------|---------------------------------|-----|----------------------|-----|-----|--------------------|-----|--|
| | | Min | Тур | Max | Min | Тур | Max | |
| V | 2.7 V ≤ V _{IN} < 3.1 V | 4.8 | 5.0 | 5.2 | | | 50 | |
| V _{OUT} | 3.1 V ≤ V _{IN} < 5.5 V | 4.0 | | 5.2 | | | 140 | |

1.2 Modifications

To aid user customization of the EVM, the board was designed with devices having 0603 or larger footprints. A real implementation likely occupies less total board space.

Changing components can improve or degrade EVM performance. For example, adding a larger output capacitor reduces output voltage undershoot but lengthens response time after a load transient event.

2 Input/Output Connector Descriptions

- **J1–VIN** This header is a positive connection to the power input supply (V_{IN}).
- **J2–GND** This header is the return connection for the bias (V_{BIAS}) supply.
- **J3–VOUT** This header is the positive connection for the output load on V_{OUT}.
- J4-GND This header is the ground return connection for the output load.
- **JP1– EN** When this jumper is installed to ON, the enable pin (EN) is tied to VIN, thereby enabling the device. When this jumper is moved to OFF, EN is pulled to ground thereby disabling the device.
- **JP2 LED ON** When this jumper is installed, VOUT is connected to the 5 paralleled WLEDs, pulling 75mA.

2.1 Test Setup

The absolute maximum voltage allowed on VIN is 5 V. In order to enable the device, move jumper JP1 to ON. When connecting external loads, use short, twisted leads.

2.2 Test Results

Figure 1 shows the test results at $T_A = 25$ °C using this EVM:



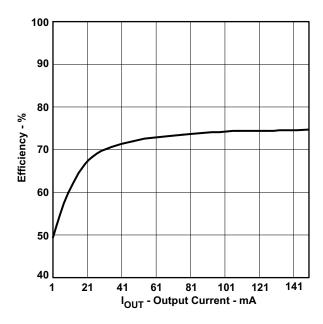


Figure 1. TPS60150 Efficiency with $V_{\rm IN}$ = 3.3 V

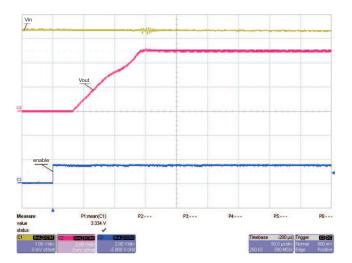


Figure 2. TPS60150 Startup with V_{IN} = 3.3 V and I_{OUT} = 75 mA



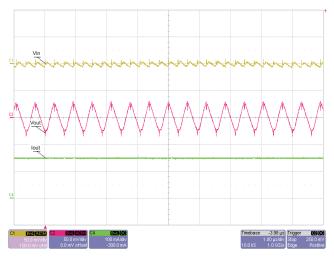


Figure 3. TPS60150 Operation with V_{IN} = 3.3 V and I_{OUT} = 150 mA

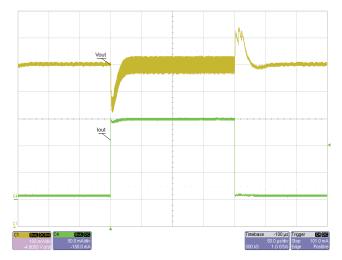


Figure 4. TPS60150 Load Transient with $V_{\rm IN}$ = 3.3 V and $I_{\rm OUT}$ = 15 mA to 150 mA



www.ti.com Board Layout

3 Board Layout

Figure 5, Figure 6, and Figure 7 show the board layout for the HPA359 PWB. See the data sheet (SLVS888) for more specific layout guidelines.

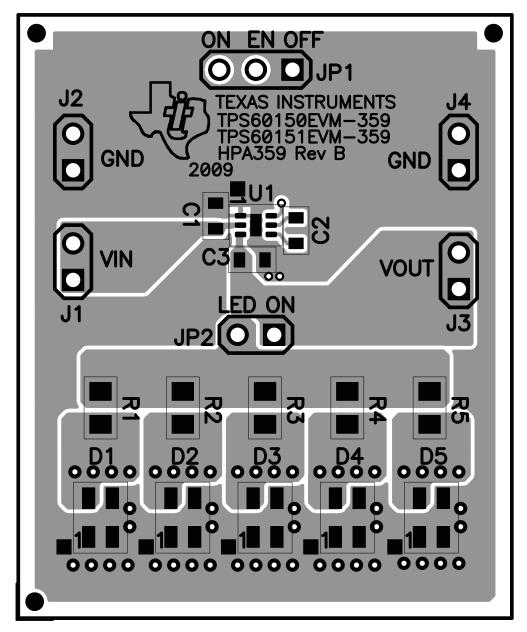


Figure 5. Top Assembly Layer



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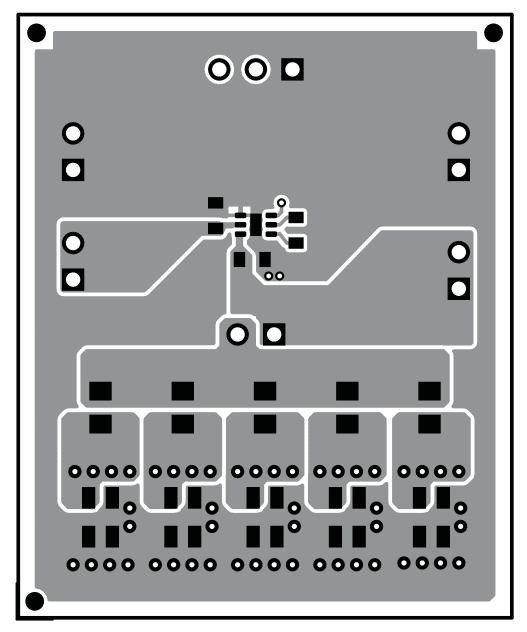


Figure 6. Top Layer



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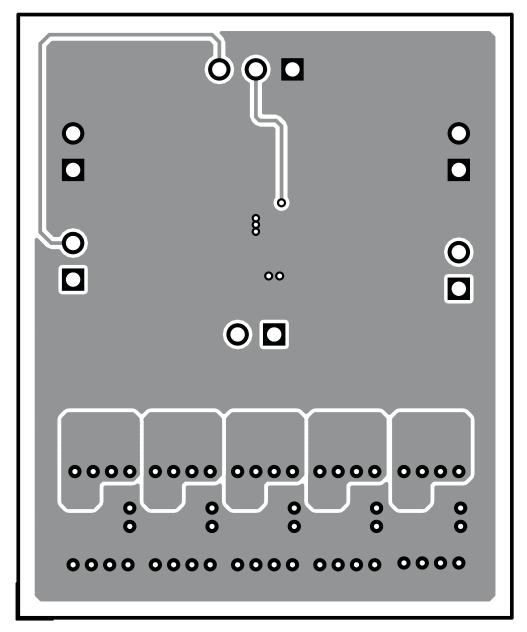


Figure 7. Bottom Layer



4 Bill of Materials and Schematic

4.1 Bill of Materials

Table 2. HPA359B Bill of Materials

| Count | | | | | | | | |
|-----------|---|-----------------------|-------------|---|----------------|-------------|---------|--|
| -001 -002 | | -002 RefDes Value Des | | Description | Size | Part Number | MFR | |
| 2 | 2 | C1, C3 | 2.2µF | Capacitor, Ceramic, 10V, X5R, 10% | 0603 | STD | STD | |
| 1 | 1 | C2 | 1μF | Capacitor, Ceramic, 10V, X5R, 10% | 0603 | STD | STD | |
| 0 | 0 | D1-D5 | LW E67C | Diode, LED, White, 30-mA, Common Anode | P-LCC-4 | LW E67C | Osram | |
| 4 | 4 | J1-J4 | PTC02SAAN | Header, 2-pin, 100mil spacing, (36-pin strip) | 0.100 inch x 2 | PTC02SAAN | Sullins | |
| 1 | 1 | JP1 | PTC03SAAN | Header, 3-pin, 100mil spacing, (36-pin strip) | 0.100 inch x 3 | PTC03SAAN | Sullins | |
| 0 | 0 | JP2 | PTC02SAAN | Header, 2-pin, 100mil spacing, (36-pin strip) | 0.100 inch x 2 | PTC02SAAN | Sullins | |
| 0 | 0 | R1–R5 | Open | Resistor, Chip, 1/10W, 1% | 0805 | Std | Std | |
| 1 | 0 | U1 | TPS60150DRV | IC, 150mA Charge Pump | SON | TPS60150DRV | TI | |
| 0 | 1 | U1 | TPS60151DRV | IC, 150mA Charge Pump | SON | TPS60150DRV | TI | |
| 2 | 2 | - | | Shunt, 100-mil, Black | 0.100 | 929950-00 | 3M | |
| 1 | 1 | | | PCB, 1.65" × 1.35" × 0.062" | | HPA359 | Any | |



4.2 Schematic Drawing

Figure 8 is the schematic for the TPS60150EVM-359.

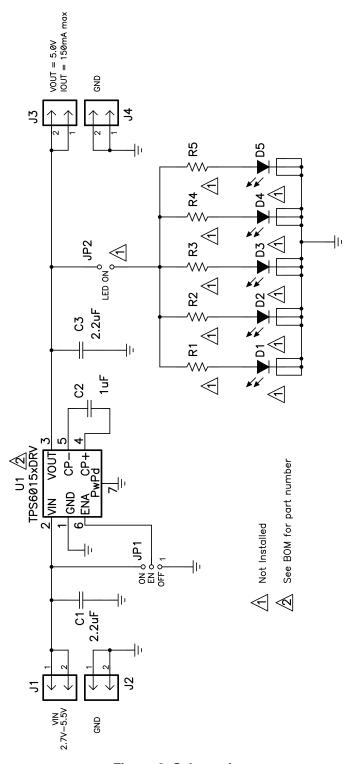


Figure 8. Schematic

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EVM Warnings and Restrictions

It is important to operate this EVM within the input voltage range of 3 V to 5 V and the output voltage range of 5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 25°C. The EVM is designed to operate properly with certain components above 25°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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